

V <sub>DSS</sub>	30V
R <sub>DS(on)</sub> (Max.)	40mΩ
I <sub>D</sub>	±4.5A
P <sub>D</sub>	1.5W

### Features

- 1) Low on resistance
- 2) High power small mold package
- 3) Pb-free lead plating; RoHS compliant
- 4) Halogen free

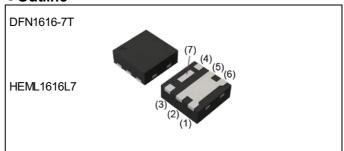
# Application

Switching

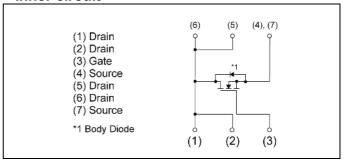
DC/DC converter

Battery switch

### Outline



### •Inner circuit



Packaging specifications

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	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
	Quantity (pcs)	3000
	Taping code	TCL1
	Marking	WF

# ● **Absolute maximum ratings** (T<sub>a</sub> = 25°C ,unless otherwise specified)

•		
Symbol	Value	Unit
$V_{DSS}$	30	V
I <sub>D</sub>	±4.5	Α
I <sub>DP</sub> *1	±18	А
$V_{GSS}$	±12	V
P <sub>D</sub> *2	1.5	W
T <sub>j</sub>	150	°C
T <sub>stg</sub>	-55 to +150	°C
	$V_{DSS}$ $I_{D}$ $I_{DP}^{*1}$ $V_{GSS}$ $P_{D}^{*2}$ $T_{j}$	$V_{DSS}$ 30 $I_{D}$ ±4.5 $I_{DP}^{*1}$ ±18 $V_{GSS}$ ±12 $P_{D}^{*2}$ 1.5 $T_{j}$ 150

### ●Thermal resistance

Parameter	Cymah al	Values			Lloit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - ambient	R <sub>thJA</sub> *2	-	1	83.4	°C/W

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Linit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0V, I_D = 1mA$	30	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_i} I_D = 1 \text{mA}$ referenced to 25°C		18	-	mV/°C	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	-	-	1	μA	
Gate - Source leakage current	I <sub>GSS</sub>	$V_{GS} = \pm 12V, V_{DS} = 0V$	-	-	±100	nA	
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 1mA$	0.5	-	1.5	V	
		I <sub>D</sub> = 1mA referenced to 25°C	-	-1.8	-	mV/°C	
Static drain - source	D *3	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4.5A	-	28	40	m0	
on - state resistance	R <sub>DS(on)</sub> *3	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 2.25A	-	41 58		mΩ	
Forward Transfer Admittance	Y <sub>fs</sub>  *3	V <sub>DS</sub> = 5.0V, I <sub>D</sub> = 4.5A	3.1	-	-	S	

<sup>\*1</sup> Pw ≤ 10µs, Duty cycle ≤ 1%

<sup>\*2</sup> Mounted on a Cu board (40×40×0.8mm)

<sup>\*3</sup> Pulsed

# ●Electrical characteristics (T<sub>a</sub> = 25°C)

Davamatav	Cymah al	Conditions	Values			l leit	
Parameter	Symbol Conditions —		Min.	Тур.	Max.	Unit	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	450	-		
Output capacitance	$C_{oss}$	V <sub>DS</sub> = 15V	-	50	-	pF	
Reverse transfer capacitance	$C_{rss}$	f = 1MHz	-	35	-		
Turn - on delay time	$t_{d(on)}^{*3}$	$V_{DD} \simeq 15V, V_{GS} = 4.5V$	1	7.2	-		
Rise time	<b>t</b> <sub>r</sub> *3	I <sub>D</sub> = 2.25A	-	5.8	-	no	
Turn - off delay time	$t_{d(off)}^{*3}$	$R_L \simeq 6.6\Omega$		13.0	-	ns	
Fall time	<b>t</b> <sub>f</sub> *3	R <sub>G</sub> = 10Ω	-	5.1	-		

# • Gate charge characteristics $(T_a = 25^{\circ}C)$

	\ u	,				
Parameter	Cymbal	Conditions	Values			Unit
raianietei	Symbol Conditions		Min.	Тур.	Max.	Offic
Total gate charge	$Q_g^{*3}$	V <sub>DD</sub> ≃ 15V.	-	4.0	-	
Gate - Source charge	Q <sub>gs</sub> *3	$V_{DD} \approx 15V,$ $I_{D} = 4.5A,$ $V_{GS} = 4.5V$	-	1.0	-	nC
Gate - Drain charge	Q <sub>gd</sub> *3	$V_{GS} = 4.5V$	-	1.0	-	

# ●Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Doromotor	Symbol Conditions		Values			l leit
Parameter			Min.	Тур.	Max.	Unit
Continuous forward current	I <sub>S</sub>	T = 25°C	-	-	1.25	Α
Pulse forward current	I <sub>SP</sub> *1	T <sub>a</sub> = 25°C	-	-	18	Α
Forward voltage	V <sub>SD</sub> *3	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.25A	-	-	1.2	V

Fig.1 Power Dissipation Derating Curve

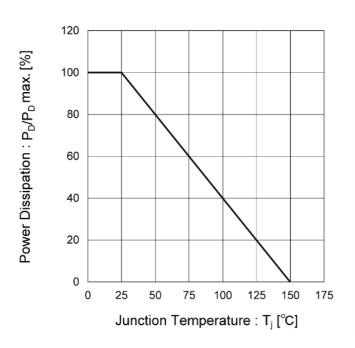


Fig.2 Maximum Safe Operating Area

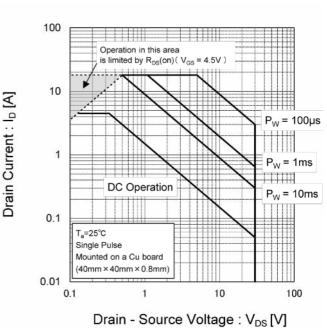


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

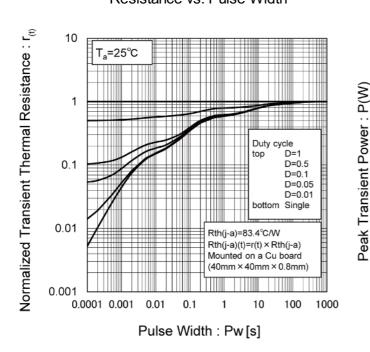


Fig.4 Single Pulse Maximum Power dissipation

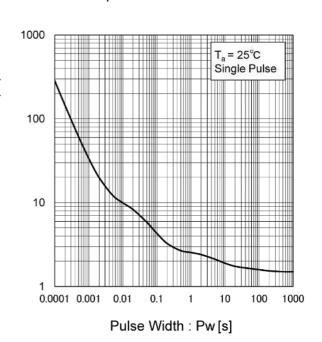


Fig.5 Typical Output Characteristics(I)

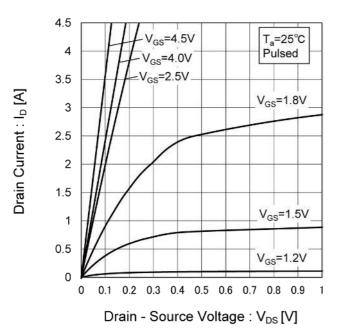
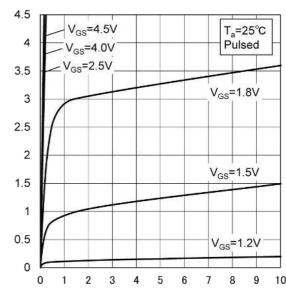


Fig.6 Typical Output Characteristics(II)



Drain Current: Ip [A]

Drain - Source Voltage : V<sub>DS</sub> [V]

Fig.7 Breakdown Voltage vs.
Junction Temperature

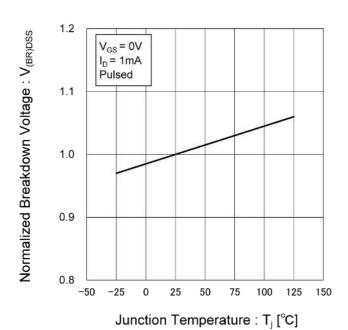
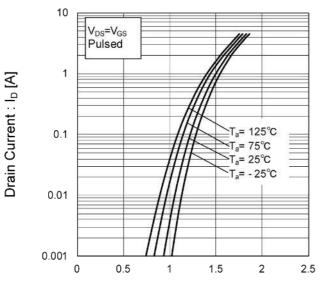
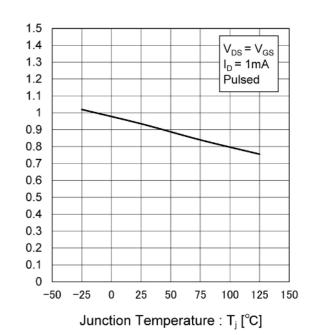


Fig.8 Typical Transfer Characteristics



Gate - Source Voltage : V<sub>GS</sub> [V]

Fig.9 Gate Threshold Voltage vs.
Junction Temperature



Gate Threshold Voltage: VGS(th) [V]

Fig.10 Forward Transfer Admittance vs.
Drain Current

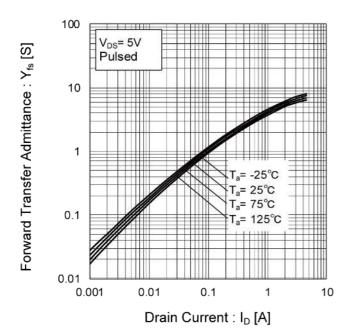


Fig.11 Drain Current Derating Curve

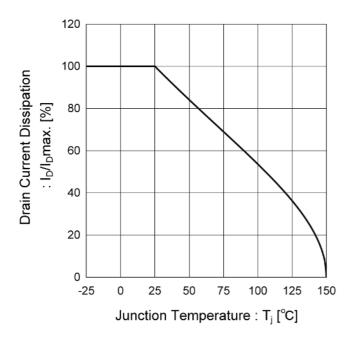


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

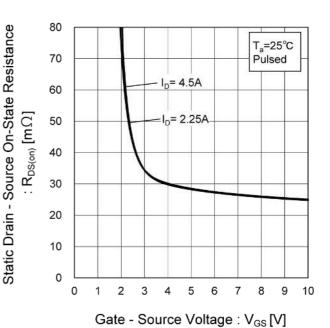


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

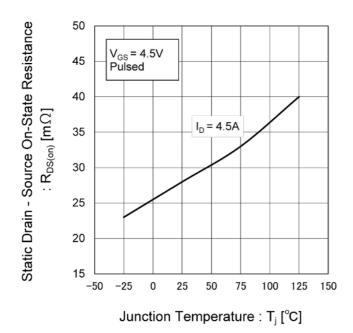


Fig.14 Static Drain - Source On - State
Resistance vs. Drain Current (I)

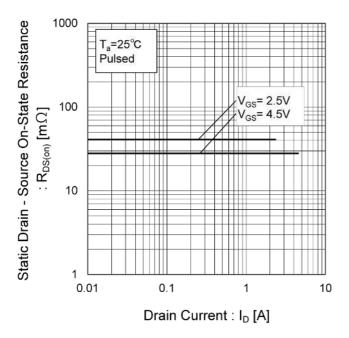


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

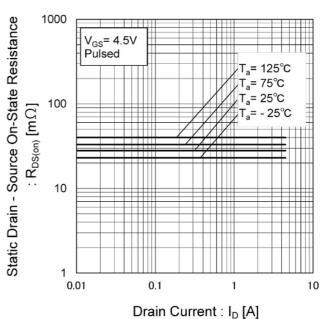


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)

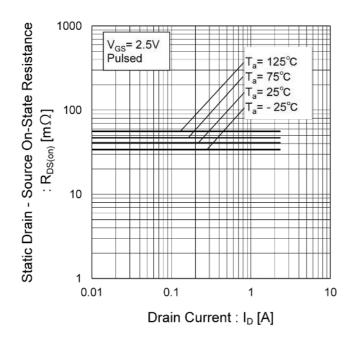


Fig.17 Typical Capacitance vs.

Drain - Source Voltage

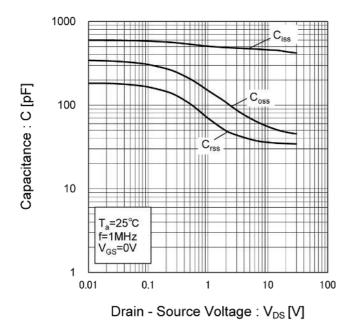


Fig.18 Switching Characteristics

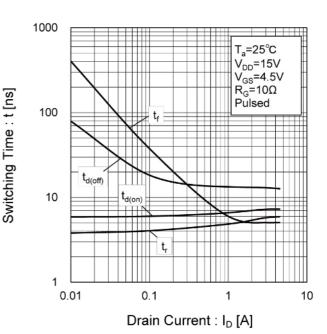


Fig.19 Dynamic Input Characteristics

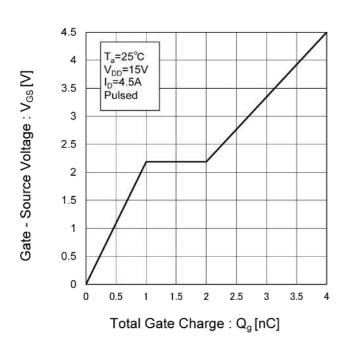
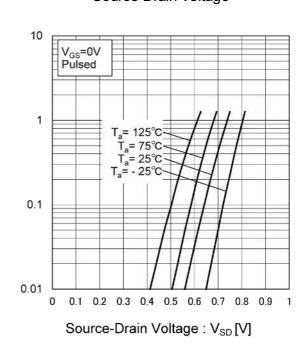


Fig.20 Source Current vs.

Source Drain Voltage



Source Current : Is [A]

### Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

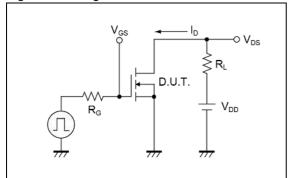


Fig.2-1 Gate Charge Measurement Circuit

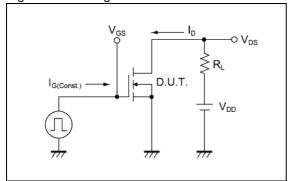


Fig.1-2 Switching Waveforms

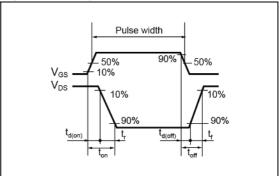
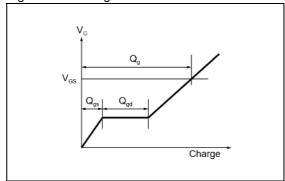


Fig.2-2 Gate Charge Waveform

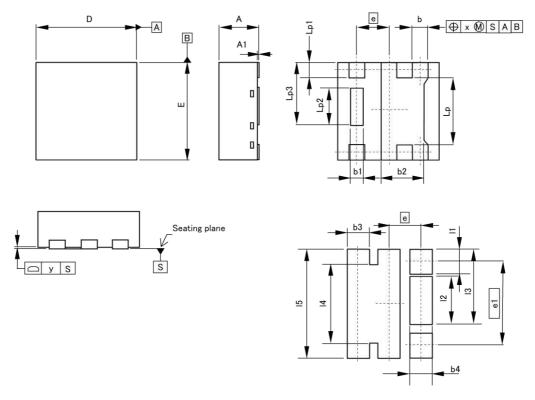


### Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

## Dimensions

DFN1616-7T HEML1616L7 (Single)



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIME	TERS	INCI	HES
DIIVI	MIN	MAX	MIN	MAX
Α	0.50	0.63	0.020	0.025
A1	0.00	0.05	0.000	0.002
b	0.20	0.30	0.008	0.012
b1	0.10	0.30	0.004	0.012
b2	0.57	0.77	0.022	0.030
D	1.50	1.70	0.059	0.067
E	1.50	1.70	0.059	0.067
е	0.	50	0.0	20
Lp	1.00	1.20	0.039	0.047
Lp1	0.15	0.35	0.006	0.014
Lp2	0.52	0.72	0.020	0.028
Lp3	0.95	1.15	0.037	0.045
х	9#	0.05		0.002
У	70	0.08	(2)	0.003

DIM	MILIME	MILIMETERS		HES	
DIM	MIN	MAX	MIN	MAX	
b3	(#)	0.35		0.014	
b4	75	0.35	20	0.014	
e1	1.	35	0.0	0.053	
l1	6 <del>73</del>	0.40	8 <b>7</b> 8	0.016	
12	-	0.77	7 <del>-</del> 3	0.030	
13		1.20	<b>(=</b> 3	0.047	
14	828	1.25	-	0.049	
15	-	1.75	-	0.069	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCTI	CLASS II b	СГУССШ
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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